Business Proprietary

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DRAMS AND DRAM MODULES FROM KOREA (Investigation No. 701-TA-431 (Preliminary))

Return completed questionnaire to:

UNITED STATES INTERNATIONAL TRADE COMMISSION Office of Investigations, Room 615 500 E Street, SW, Washington, DC, U.S.A. 20436

So as to be received by the Commission by no later than November 15, 2002

CERTIFICATION

I certify that the information herein supplied in response to this questionnaire is complete and correct to the best of my knowledge and belief and understand that the information submitted is subject to audit and verification by the Commission.

By signing this certification I also grant consent for the Commission, and its employees and contract personnel, to use the information provided in this questionnaire and throughout this investigation in any other import-injury investigations conducted by the Commission on the same or similar merchandise. (If you do not consent to such use, please note the certification accordingly.)

I acknowledge that information submitted in this questionnaire response and throughout this investigation may be used by the Commission, its employees, and contract personnel who are acting in the capacity of Commission employees, for developing or maintaining the records of this investigation or related proceedings for which this information is submitted, or in internal audits and investigations relating to the programs and operations of the Commission pursuant to 5 U.S.C. Appendix 3. I understand that all contract personnel will sign non-disclosure agreements.

| Name and Title of Authorized Official | Date | | |
|---------------------------------------|----------------|-----------|--|
| Signature of Authorized Official | () Phone | () Fax | |
| | E-mail address | | |
| FIRM NAME AND ADDRESS | | | |
| | | | |
| | | | |

The questions in this questionnaire have been reviewed with market participants to ensure that issues of

concern are adequately addressed and that data requests are sufficient, meaningful, and as limited as possible. Public reporting burden for this questionnaire is estimated to average 40 hours per response, including the time for reviewing instructions, searching existing data sources, gathering the data needed, and completing and reviewing the questionnaire. Send comments regarding the accuracy of this burden estimate or any other aspect of this collection of information, including suggestions for reducing the burden, to the Office of Investigations, U.S. International Trade Commission, 500 E Street, SW, Washington, DC 20436. Please report below the actual number of hours required and the cost to your firm of preparing the reply to this questionnaire and completing the form. _____dollars hours PART I.--OPERATIONS IN KOREA I-1. Please report the production capacity of DRAMs and DRAM modules produced by your firm in Korea on page 6; please also report the production, shipments, and inventories of uncased, DRAMs, cased DRAMs, and DRAM modules on pages 7, 8, and 9, respectively. I-2. What percentage of your firm's total sales in its most recent fiscal year was represented by sales of DRAMs and DRAM modules? Percent I-3-A. Does your firm produce products other than DRAMs and DRAM modules on the same equipment and machinery used in the production of DRAMs and DRAM modules? Yes--Please list these product(s) and provide the share of your firm's total net sales (in percent) accounted for by these product(s) in its most recent fiscal year. Product(s) Share of sales I-3-B. Please provide the share (in percent) of your total wafer starts accounted for by DRAM wafers in each of the following periods: 1999 ; 2000 ; 2001 ; Jan.-Sept. 2001 ; Jan.-Sept. 2002 I-3-C. Please provide the share (in percent) of your total assembly capability accounted for by cased DRAMs in each of the following periods:

1999 _____; 2000 _____; 2001 _____; Jan.-Sept. 2001 _____; Jan.-Sept. 2002 _____

PART I.--OPERATIONS IN KOREA--Continued

| production of DRAMs or D | KAWI Modules III Kolea: | |
|---|--|------------------------|
| No YesPlease d quantities invo | escribe those plans, including planned dat olved. | es and capacity/prod |
| | | |
| | | |
| | | |
| Are the DRAMs or DRAM findings or remedies in any | modules exported by your firm subject to WTO-member countries? | antidumping or subs |
| findings or remedies in any | | |
| findings or remedies in any | WTO-member countries? | |
| findings or remedies in any No YesList the | WTO-member countries? products(s), countries affected and the dat | te of such findings/re |
| findings or remedies in any No YesList the | WTO-member countries? products(s), countries affected and the dat | te of such findings/re |

PART II.-OPERATIONS IN THE UNITED STATES

| II-1. | Please provide the names and addresses of the <u>TEN</u> largest U.S. importers of your firm's DRAMs and DRAM modules in 2001. |
|-------|--|
| | |
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| | |
| | |
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| | |
| | |
| | |
| | |
| II-2. | Does your firm or any related firm produce, have the capability to produce, or have any plans to produce DRAMs or DRAM modules in the United States? |
| | No YesPlease name the firm(s) below and ensure that they complete the Commission's producer questionnaire (contact Mary Messer (202-205-3193) for copies of that questionnaire). |
| | |
| | |
| II-3. | Does your firm or any related firm import or have any plans to import DRAMs or DRAM modules into the United States? |
| | No YesPlease name the firm(s) below and ensure that they complete the Commission's importer questionnaire (contact Mary Messer (202-205-3193) for copies of that questionnaire). |
| | |
| | |

PART II.--OPERATIONS IN THE UNITED STATES-Continued

| Uncased DRAMs Cased DRAMs DRAM modules Does your firm sell DR No Yes-Plead DRAMs | | noting the estin | nated percenta | ge of your firm's | total sal |
|--|------------------------------|------------------------------|----------------------------------|-----------------------------------|------------|
| DRAM modules Does your firm sell DR No Yes-Plea | se describe, | noting the estin | nated percenta | ge of your firm's | total sal |
| Does your firm sell DR | se describe, | noting the estin | nated percenta | ge of your firm's | total sal |
| □ No □ Yes–Plea | se describe, | noting the estin | nated percenta | ge of your firm's | total sal |
| Describe the significan Samsung Korean DRA was in effect from May | Ms \$ 1-Meg v 10, 1993, u | and DRAM montil October 5, 2 | odules contain 2000, in terms | ing any DRAMs of its effect on ye | \$ 1-Meg |
| exports, shipments, and its termination. Use ad | | | | and any effects o | f resultir |
| | | | | | |
| | | | | | |

¹ Such firms will report inventories in the Commission's importer or producer questionnaire.

II-1. <u>ALL DRAMS</u>.--For your Korean establishment(s) wherein DRAM wafers are fabricated (UNCASED DRAMS), assembled (CASED), and/or assembled into modules, report the average-of-period full production capabilities (i.e., capacity--see definitions in instructions booklet). In reporting the capacity and wafer starts requested below for UNCASED DRAMS, please consider the capacity utilization (i.e., wafer starts divided by capacity) experienced by your Korean establishments wherein DRAM wafers are fabricated. Also, estimate for each period the probe yield (i.e., the percentage of usable die per wafer). For CASED DRAMS, please consider the capacity utilization (i.e., assembly divided by assembly capacity) of your DRAM assembly facilities.

| | Calendar years | | | January-September | | Projections | |
|--|----------------|---------------|----------------|-------------------|---------------|-------------|--------------------|
| Item | 1999 | 2000 | 2001 | 2001 | 2002 | 2002 | 2003 |
| UNCASED DRAMS: ¹ Average capacity ² (1,000 8-inch-equivalent wafers) | | | | | | | |
| Wafer starts (1,000 8-inch-equivalent wafers) | | | | | | | |
| Probe yield (percent) | | | | | | | |
| CASED DRAMS: Average capacity ³ (1,000 units) | | | | | | | |
| Assembly ⁴ (1,000 units) | | | | | | | |
| DRAM MODULES: Average capacity ⁵ (1,000 units) | | | | | | | |
| Assembly (1,000 units) | | | | | | | |
| inches) of silicon wafers actually fabricated by your firm to be used in the production of DRAMs. ² The average capacity reported is based on operating hours per week, weeks per year. Briefly explain assumptions made and methods used in calculating the estimates reported above for practical capacity to fabricate DRAM wafers. Also explain any changes in reported capacity. Use additional pages as necessary | | | | | | | |
| ³ The average capacity reported is based on operating hours per week, weeks per year. Briefly explain assumptions made and methods used in calculating the estimates reported above for average capacity to assemble DRAMs. Also explain any changes in reported capacity. Use additional pages as necessary | | | | | | | |
| ⁴ The data reported for all DRAMs assembled should equal the totals of production for all densities of all cased DRAMs reported in question II-3 . If data do not reconcile, please explain, using additional pages as necessary. | | | | | | | |
| ⁵ The average capacity repe explain assumptions made and assemble DRAM modules. Als as necessary. | d methods us | ed in calcula | ting the estin | nates reporte | d above for a | verage capa | Briefly city to |

UNCASED DRAMS FABRICATED IN KOREA.--Report your firm's production, shipments, and

PART II.--TRADE AND RELATED INFORMATION--Continued

II-2.

| inventories related to the production of uncased DRAMs in your Korean establishment(s) during the specified periods. Report separately for each density of DRAM your firm produces, photocopying this page as necessary. Identify the density reported on each page by checking the appropriate box. (See definitions in the instruction booklet.) | | | | | | | |
|--|----------------|------|------|----------|-----------|-------|--------|
| □ 16 Meg □ 64 Meg □ 128 Meg □ 256 Meg □ 512 Meg □ Other (specify density) | | | | | | | |
| Quantity (in 1,000 units) | | | | | | | |
| | Calendar years | | | January- | September | Proje | ctions |
| Item | 1999 | 2000 | 2001 | 2001 | 2002 | 2002 | 2003 |
| Beginning-of-period inventories | | | | | | | |
| Production ¹ | | | | | | | |
| SHIPMENTS: Home-market shipments: Company transfers/ internal consumption for making cased DRAMs | | | | | | | |
| Other company transfers/ internal consumption (identify the nature of the transfers/consumption: | | | | | | | |
| Home-market commercial shipments | | | | | | | |
| EXPORT SHIPMENTS TO The United States: To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| Other export markets: ² To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| End-of-period inventories ³ | | | | | | | |
| 1 Reported production should include only usable units (i.e., net of any losses that occur during wafer fabrication and sorting). 2 Identify your principal export markets: 3 Reconciliation of data.—Please note that the quantities reported above should reconcile as follows: beginning-of-period inventories, plus production, less total shipments, equals end-of-period inventories. Do the data reported reconcile? Yes NoPlease explain: | | | | | | | |

| (See definitions in the instruction booklet.) Report separately for each density of DRAM your firm assembles, by the location of the fabrication of the dice, photocopying this page as necessary. Identify: (1) the density, and (2) the dice fabrication location reported on each page by checking | | | | | | | |
|--|---|---------------|-----------------|-------------------|----------------|----------------|------------------------|
| one box per categor | y below. | , | | • | | | G |
| 1) Density: 16 Meg 64 Meg | _ | | | | | | |
| 2) Dice fabrication location: U | nited States | Korea 🗆 (| Other locations | (specify: | | | |
| | | Quantit | y (in 1,000 i | units) | | | |
| | C | alendar yea | rs | January-September | | Projections | |
| Item | 1999 | 2000 | 2001 | 2001 | 2002 | 2002 | 2003 |
| Beginning-of-period inventories | | | | | | | |
| Production (assembly): ¹ | | | | | | | |
| SHIPMENTS: Home-market shipments: Company transfers/ internal consumption for making DRAM modules | | | | | | | |
| Other company transfers/ internal consumption (identify the nature of the transfers/consumption: | | | | | | | |
| Home-market commercial shipments | | | | | | | |
| EXPORT SHIPMENTS TO The United States: To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| Other export markets: ² To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| End-of-period inventories ³ | | | | | | | |
| ¹ Reported production should addition, reported production shourchased. ² Identify your principal exposional reports and rep | nould include ort markets: _ ease note that | assembly of a | all dice, wheth | er internally tr | ansferred or i | mported or oth | nerwise ngof-period |
| ☐ Yes ☐ NoPlease explair | n: | | | | | | |

Yes No--Please explain:

| II-4. DRAM MODULES | | | | | | | |
|---|------------------|-----------------|--|-----------------|-------------------|---------------|--------------|
| inventories related to | | | | | | | |
| specified periods. (S | | | | | | | |
| fabrication location necessary, checking | | | | | | | |
| DRAM assembly lo | | | | uice labilica | ation location | ii, anu (2) C | ascu |
| Didn't assembly to | cation repo | rea on each | n puge. | | | | |
| | | 1 | | | | | |
| 1) Dice fabrication location: \square Ur | nited States L | 」Korea □ C | Other locations | (specify: | | | |
| 2) Cased DRAMs assembly locatio | n: United S | States | rea Other | locations (spec | ify: | | |
| | | 0 44 | /• · · · · · · · · · · · · · · · · · · · | * • • > | | | |
| | | | y (in billion | <u> </u> | | | |
| | | alendar year | 1 | - | September | Projections | |
| ltem | 1999 | 2000 | 2001 | 2001 | 2002 | 2002 | 2003 |
| Beginning-of-period inventories | | | | | | | |
| Production (assembly): ¹ | | | | | | | |
| SHIPMENTS: | | | | | | | |
| Home-market shipments: Company transfers/ | | | | | | | |
| internal consumption | | | | | | | |
| (identify the nature of the transfers/consumption: | | | | | | | |
| | | | | | | | |
| Home-market commercial | | | | | | | |
| shipments | | | | | | | |
| EXPORT SHIPMENTS TO The United States: | | | | | | | |
| To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| Other export markets:2 | | | | | | | |
| To foreign affiliates | | | | | | | |
| To other firms | | | | | | | |
| End-of-period inventories ³ | | | | | | | |
| ¹ Reported only usable modu | ules(i.e., net c | of any losses t | hat occur du | ring assembly | and testing). | | |
| Identify your principal expo Reconciliation of dataPle | ase note that | the quantitie | s reported a | bove should re | econcile as follo | ows: beginnir | ng-of-period |
| inventories, plus production, les | | | | | | | |

| 11-5. | Do you always know the countr DRAMs? | ry of fabri | leation for your purchases and internal transfers of uncased | | | |
|-------|---|-------------|--|--|--|--|
| | □ No □ Yes | | | | | |
| II-6. | Do you always know the countrinternal transfers of cased DRA | | cation and the country of assembly for your purchases and | | | |
| | Uncased DRAM fabrication: □ | ∃No | □Yes | | | |
| | Cased DRAM assembly: | No | □Yes | | | |
| II-7. | Do you always know the countrinternal transfers of DRAM mo | | ication and the country of assembly for your purchases and | | | |
| | Uncased DRAM fabrication: | □No | □Yes | | | |
| | Cased DRAM assembly: | No | □Yes | | | |
| | DRAM module assembly: | No | □Yes | | | |
| II-8. | Please identify each country in which your firm or a related firm performs the following DRAM operations: | | | | | |
| | Operation | | Countries | | | |
| | Uncased DRAM fabrication | | | | | |
| | Cased DRAM assembly | | | | | |
| | DRAM module assembly | | | | | |